

Report No. APR-25-H0112 Date: Jun.16, 2025

# RENESAS SEMICONDUCTOR RELIABILITY REPORT

APPLICATION: High Quality

SERIES: REXFET-1 ANL4

**DEVICE:** Refer to Product List

Quality Assurance Div. Renesas Electronics Corporation

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## **Q101 Qualification Test Results**

[Note: Basically qualification tests were performed using a representative product with the same wafer process and the same package structure.]

Test	#	Reference	Test Conditions	Lots	S.S.	Total	Results (Fail of Total)	Comments: (N/A =Not Applicable)
			TEST GROUP A – ACCELERAT	ED ENVI	RONMEN'	Γ STRESS	TESTS	
PC	A1	JESD22-A113 J-STD-020	SMD only; Moisture Preconditioning for HAST/H3TRB,UHAST/AC,TC,IOL/PTC.	3	308	924	0 of 924	-
HAST	A2	JESD22-A110	Ta=130°C, RH=85%, VDSS=Maximum rating, 96h	-	-	-	-	See H3TRB.
H3TRB	A2 alt	JESD22-A101	Ta=85°C, 85%RH, VDSS=Maximum rating, 1,000h	3	77	231	0 of 231	-
UHAST	A3	JESD22-A118 or A101	Ta=130°C, RH=85%, 96h	3	77	231	0 of 231	-
AC	A3 alt	JESD22-A102	Ta=121°C, 100%RH, 96h	-	-	-	-	See UHAST.
ТС	A4	JESD22-A104 Appendix 6	Ta=-55°C to 150°C, 1,000cycles	3	77	231	0 of 231	-
ТСНТ	A4a	JESD22-A104 Appendix 6	TC Hot Test.	-	-	-	-	N/A Not wire, clip bond
TCDT	A4a alt	JESD22-A104 Appendix 6 J-STD-035	TC Delamination Test.	-	-	-	-	N/A Not wire, clip bond
IOL	A5	MIL-STD-750 Method 1037	ΔTc=100°C, 15,000cycles	3	77	231	0 of 231	-
PTC	A5 alt	JESD22-A105	Power Temperature Cycling.	-	-	-	-	See IOL.

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Test	#	Reference	Test Conditions	Lots	S.S.	Total	Results (Fail of Total)	Comments: (N/A =Not Applicable)
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#### TEST GROUP B – ACCELERATED LIFETIME SIMULATION TESTS

HTRB	I R1	MIL-STD-750-1 M1039	Tch=175°C, VDSS=Maximum rating, 1,000h	3	77	231	0 of 231	-
ACBV	Bla	MIL-STD-750-1 M1040 Test condition A	AC blocking voltage.	-	-	-	-	N/A Thyristors Only.
SSOP	B1b	MIL-STD-750-1 M1038 condition B (Zeners)	Steady State Operational.	1	1	-	-	N/A Voltage Regulators (Zeners) Only.
HTGB	B2	JESD22-A108	Tch=175°C, VGSS=+20V, 1,000h	3	77	231	0 of 231	-

#### TEST GROUP C - PACKAGE ASSEMBLY INTEGRITY TESTS

DPA	C1	AEC Q101-004 Section4	Random sample of parts that have successfully completed H3TRB or HAST and TC.	3	4	12	0 of 12	-
PD	C2	JEDEC JESD22-B100	Physical Dimensions.	1	30	30	0 of 30	-
WBP	С3	MIL-STD-750-2 Method 2037	Wire Bond Pull.	ı	-	ı	-	N/A Not wire, clip bond
WBS	C4	AEC Q101-003 JESD22-B116	Wire Bond Shear Test.	ı	-	ı	-	N/A Not wire, clip bond
DS	C5	MIL-STD-750-2 Method 2017	Die Shear.	ı	-	ı	-	N/A Not wire, clip bond
TS	C6	MIL-STD-750-2 Method 2036	Terminal Strength.	ı	-	ı	<u> </u>	N/A SMD
RTS	С7	JESD22-B107	Resistance to Solvents.	1	-	1	_	N/A laser etched parts
RSH	C8	JESD22-A111 (SMD)	Resistance to Solder Heat.	-	-	-	-	N/A Wave solder deprecated.

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Test	#	Reference	Test Conditions	Lots	S.S.	Total	Results (Fail of Total)	Comments: (N/A =Not Applicable)
TR	С9	JESD24-3, 24-4, 24-6 as appropriate	Thermal Resistance.	1	10	10	0 of 10	-
SD	C10	JEDEC J-STD-002	Solderability: (>95% coverage)	3	10	30	0 of 30	-
WG	C11	AEC Q005	see AEC-Q005	ı	-	-	Pass	Performed on product TEG with test method based on JESD201.
CA	C12	MIL-STD-750-2 Method 2006	Constant Acceleration.	1	ı	-	-	N/A hermetic packaged devices only
VVF	C13	JESD22-B103	Vibration Variable Frequency.	ı	ı	-	-	N/A hermetic packaged devices only
MS	C14	JESD22-B104	Mechanical Shock.	ı	-	-	-	N/A hermetic packaged devices only
HER	C15	JEDEC JESD22-A109	Hermeticity.	-	-	-	-	N/A hermetic packaged devices only

### TEST GROUP D - DIE FABRICATION RELIABILITY TESTS

DI	D1 Se		Dielectric Integrity.	1	5	5	0 of 5	Confirmed by process TEG
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### TEST GROUP E – ELECTRICAL VERIFICATION TESTS

EV	ЕО	JESD22-B101	External Visual.	All	All	All	0 of All	-
TEST		User/Supplier Specification	Pre and Post Stress Electrical Test.	All	All	All	0 of All	-
PV	E2	Individual AEC user specification	Parametric Verification.	3	25	75	0 of 75	-
ESDH	Е3	AEC Q101-001	Electrostatic Discharge, Human Body Model.	1	30	30	0 of 30	HBM : C:100pF,R:1.5K $\Omega$ ,See product list for withstand voltage

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Test	#	Reference	Test Conditions	Lots	S.S.	Total	Results (Fail of Total)	Comments: (N/A =Not Applicable)
ESDC	E4	AEC Q101-005	Electrostatic Discharge, Charged Device Model.	1	30	30	0 of 30	CDM : ±1000V↑
UIS	H-5	AEC Q101-004 Section2	UNCLAMPED INDUCTIVE SWITCHING.	1	5	5	0 of 5	-
SC	E6	AEC Q101-006	Short Circuit Characterization.	-	-	-	-	N/A For smart power parts only.

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#### Calculation method of standard failure

·Calculation method of standard failure rate

Operating reliability is decided by inherent reliability of device and environment condition of use (See below).

• Calculation method of standard failure reta ( $\lambda$ )

(1)Basic failure rate(λb)

Series Name: **REXFET-1 ANL4**   $\lambda b: 1.17$ (Fit)

②Temperature parameter  $(\pi T)$ 

$$\pi T = \exp(11600 \times Ea \times \left(\frac{1}{273 + 55} - \frac{1}{273 + \text{Ta(j)}}\right)$$

Ea : Activation energy

Ti(Tch) : junction temperature

	$\pi T$ simplified chart									
Ea(eV)	Ea(eV) Tj(Tch) 40 55 60 65 70 75 80 90 100 110									
0.8	0.9 -T 0.26 1.00 1.52 2.21 2.45 5.09 7.42 15.20 20.27 59.14									

③Power source voltage parameter  $(\pi V)$  (Si series transistor products, FET only)

$$S = \frac{supply \, voltage \quad (\textit{VCE or VDS})}{absolute \, maximum \, voltage \, (\textit{VCES or VDSS})}$$

$$S > 0.2 \qquad \pi \, V = e \, x \, p \quad (2.86 \quad \times \quad S - 2.29)$$

$$S \le 0.2 \qquad \pi \, V = 0.18$$

**4**MTTF (Mean Time To Failure)

MTTF and failure rate have the following relationship in the contingent failure domain

MTTF = 
$$\frac{1}{\lambda}$$
 × 10° (h) MTTF \* = 854,700,855 (h) (\*  $\pi$ T=1,  $\pi$ V = 1)

Calculation standard

• Confidence level 60% • Standard temperature  $T_j = 55$ °C

 $\pi V = 0.18$ 

• Use within recommended conditions

### **Product List**

No.	Product	HBM(V)
1	RBA100N04DANS-4UA02#HB0	2000
2	RBA80N04DANS-4UA04#HB0	2000
3	RBA100N04DANS-4UB02#HB0	2000
4	RBA80N04DANS-4UB03#HB0	2000
5	RBA50N04DANS-4UA06#HB0	1000
6	RBA50N04DANS-4UB05#HB0	1350
7	RBA30N04DANS-4UB10#HB0	650